

INTERNATIONAL STANDARD

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**Materials for printed boards and other interconnecting structures -
Part 2-52: Reinforced base materials clad and unclad - Thermosetting
hydrocarbon resin system, woven E-glass reinforced laminate sheets of defined
flammability (vertical burning test), copper-clad**

**Matériaux pour circuits imprimés et autres structures d'interconnexion -
Partie 2-52: Matériaux de base renforcés, métallisés et non métallisés - Feuilles
stratifiées renforcées en tissu de verre de type E avec système de résines
d'hydrocarbure thermodurcissables, d'inflammabilité définie (essai de
combustion verticale), plaquées cuivre**



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INTERNATIONAL ELECTROTECHNICAL COMMISSION

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Draft	Report on voting
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Full information on the voting for its approval can be found in the report on voting indicated in the above table.

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